MSHM100N20

N-Channel 100-V (D-S) MOSFET

Description

The device is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent $R_{DS(ON)}$ and gate charge for most of the synchronous buck converter applications.

The device meets the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- $R_{DS(ON)}$ =20mΩ@ V_{GS} =10V
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Typical Applications

- Networking
- Load Switch
- LED Applications

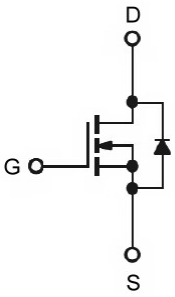
Package type：PDFN 3.3X3.3

Packing & Order Information

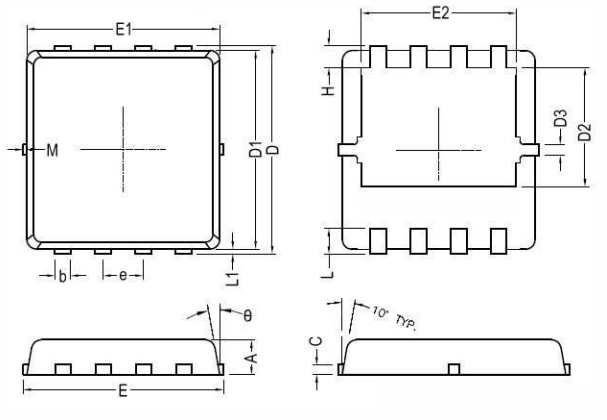
3,000/Reel

RoHS Compliant

Graphic Symbol

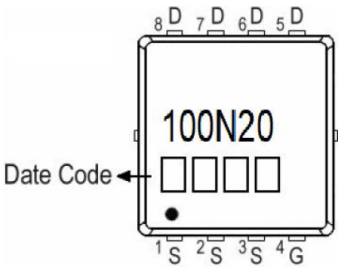


Package Dimension



REF.	Millimeter			REF.	Millimeter		
	Min.	Nom.	Max.		Min.	Nom.	Max.
A	0.70	0.75	0.80	E1	3.00	3.15	3.20
b	0.25	0.30	0.35	E2	2.39	2.49	2.59
C	0.10	0.15	0.25	e	0.65 BSC		
D	3.25	3.35	3.45	H	0.30	0.39	0.50
D1	3.00	3.10	3.20	L	0.30	0.40	0.50
D2	1.78	1.88	1.98	L1	-	0.13	0.20
D3	-	0.13	-	θ	-	10°	12°
E	3.20	3.30	3.40	M	-	-	0.15

Marking



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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Continuous Drain Current[1] (T_C =25°C)	28	A
	Continuous Drain Current[1] (T_C =100°C)	17.7	A
I_{DM}	Pulsed Drain Current[1,2]	112	A
I_{AS}	Single Pulse Avalanche Current, L =0.1mH[3]	32	A
E_{AS}	Single Pulse Avalanche Energy, L =0.1mH[3]	51	mJ
P_D	Power Dissipation[4] (T_C =25°C)	44	W
T_J/T_{STG}	Operating Junction and Storage Temperature	-55 to +150	°C

Thermal Resistance Ratings

Symbol	Parameter	Maximum	Units
$R_{\theta JA}$	Maximum Junction-to-Ambient[1]	62	°C/W
$R_{\theta JC}$	Maximum Junction-to-Case[1]	2.82	°C/W

Electrical Characteristics (T_J=25°C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GS\ (th)}$	Gate Threshold Voltage	V_{DS} =V_{GS}, I_D =250μA	1.0	1.6	2.5	V
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V, I_D =250μA	100	-	-	V
g_{fs}	Forward Transconductance	V_{DS} =10V, I_D =3A	-	11	-	S
I_{GSS}	Gate-Source Leakage Current	V_{DS} =0V, V_{GS} =±20V	-	-	±100	nA
I_{DSS}	Drain-Source Leakage Current	V_{DS} =80V, V_{GS} =0V, T_J =25°C V_{DS} =80V, V_{GS} =0V, T_J =55°C	-	-	1 10	μA
$R_{DS\ (on)}$	Static Drain-Source On-Resistance[2]	V_{GS} =10V, I_D =12A V_{GS} =4.5V, I_D =8A	- -	17 22	20 29	mΩ
EAS	Single Pulse Avalanche Energy[5]	V_{DD} =50V, L =0.1mH, I_{AS} =20A	20	-	-	mJ
V_{SD}	Diode Forward Voltage[2]	I_S =1A, V_{GS} =0V, T_J =25°C	-	-	1.2	V
I_S	Continuous Source Current[1,6]	V_G =V_D =0V, Force Current	-	-	28	A
I_{SM}	Pulsed Source Current[2,6]		-	-	56	

Notes

1. The data tested by surface mounted on a 1 inch^2 FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. The EAS data shows maximum rating. The test condition is V_{DD}=50V, V_{GS}=10V, L=0.1mH, I_{AS}=32A.
4. The power dissipation is limited by 150℃ junction temperature.
5. The Min. value is 100% EAS tested guarantee.
6. The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation.

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Dynamic

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Q_g	Total Gate Charge[2]	V_{DS} =50V	--	12.5	--	nC
Q_{gs}	Gate-Source Charge	I_D =15A	--	1.5	--	
Q_{gd}	Gate-Drain Charge	V_{GS} =10V	--	4.3	--	
$t_{d(on)}$	Turn-On Delay Time[2]	V_{DS} =50V	--	20	--	ns
t_r	Rise Time	I_D =15A	--	30	--	
$t_{d(off)}$	Turn-Off Delay Time	V_{GS} =10V	--	55	--	
t_f	Fall Time	R_G =6Ω	--	30	--	
C_{ISS}	Input Capacitance	V_{DS} =50V	--	690	--	pF
C_{OSS}	Output Capacitance	V_{GS} =0V	--	135	--	
C_{RSS}	Reverse Transfer Capacitance	f =1.0MHz	--	6	--	
Rg	Gate Resistance	V_{GS} =V_{DS} =0V, f =1.0MHz	--	0.8	--	Ω

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- **Typical Electrical Characteristics**

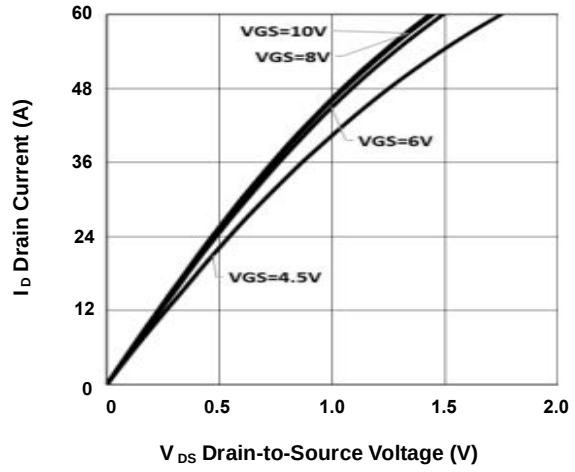

FIG.1-Typical Output Characteristics

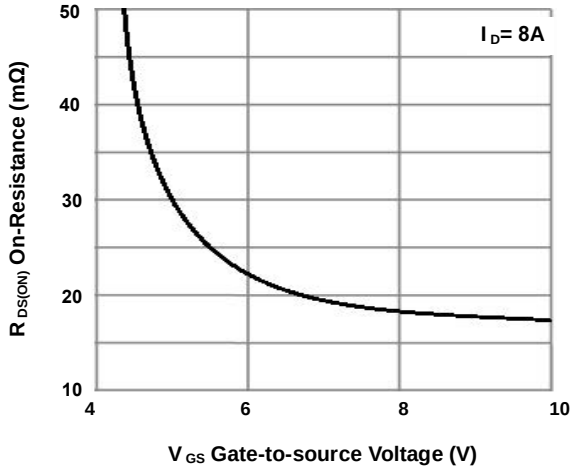

FIG.2-On-Resistance vs. G-S Voltage

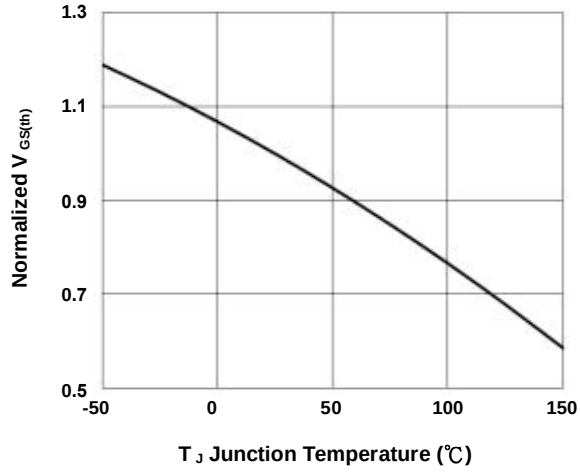

FIG.3-Normalized $V_{GS(th)}$ vs. T_J

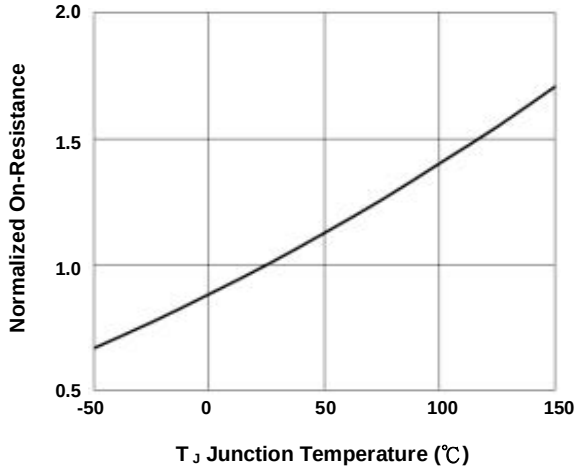

FIG.4-Normalized R_{DSON} vs. T_J

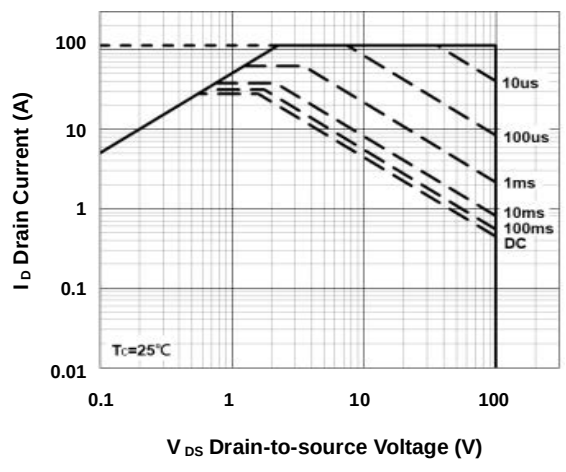

FIG.5-Safe Operating Area

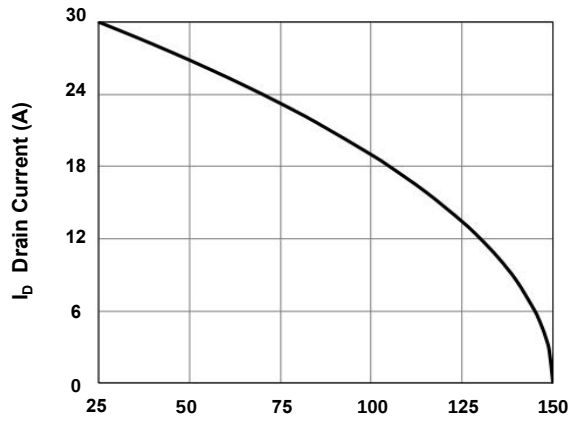

FIG.6-Continuous Drain Current vs. TC

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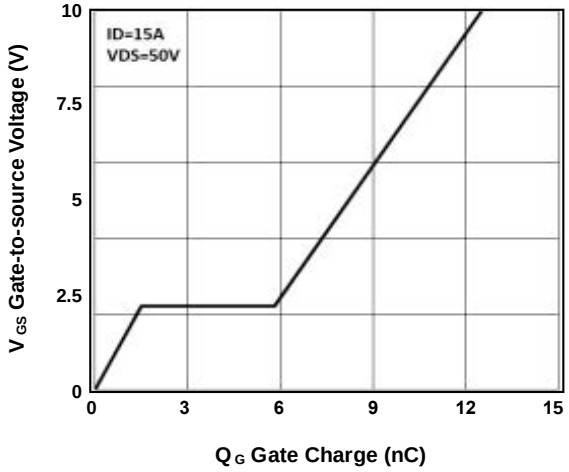

FIG.7-Gate Charge Characteristics

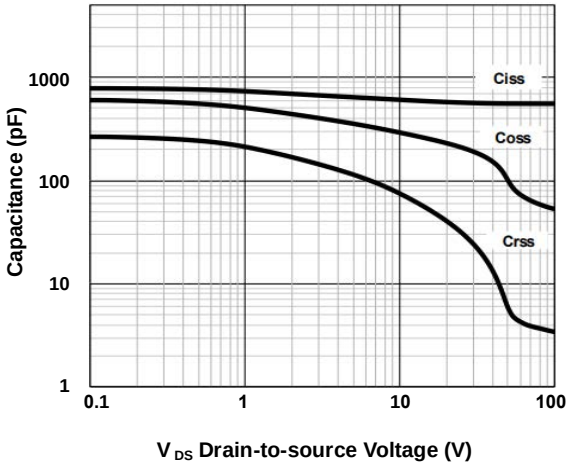

FIG.8-Capacitance Characteristics

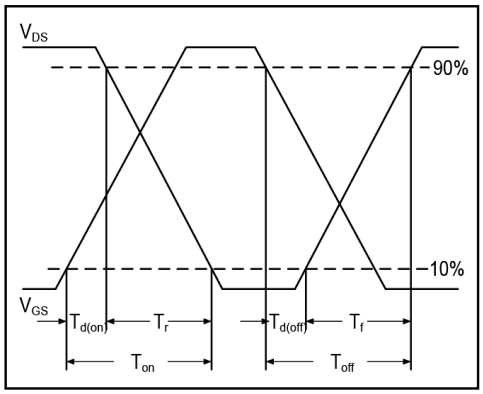

FIG.9-Switching Time Waveform

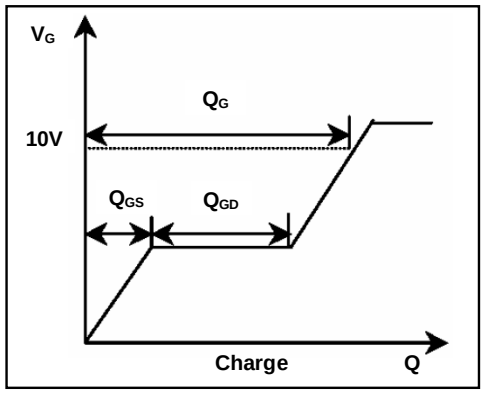

FIG.10-Gate Charge Waveform

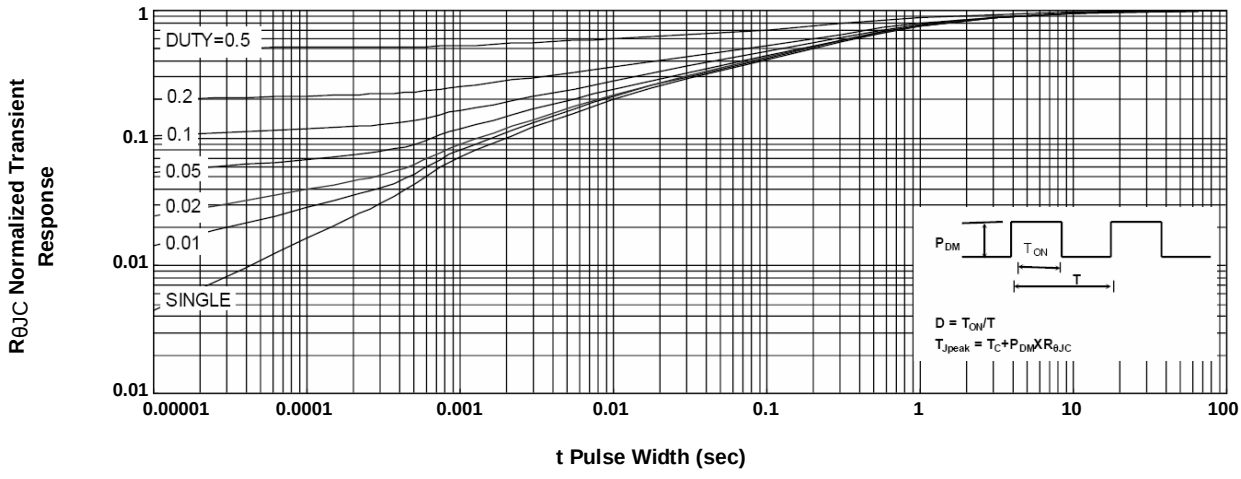

FIG.11-Normalized Maximum Transient Thermal Impedance

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